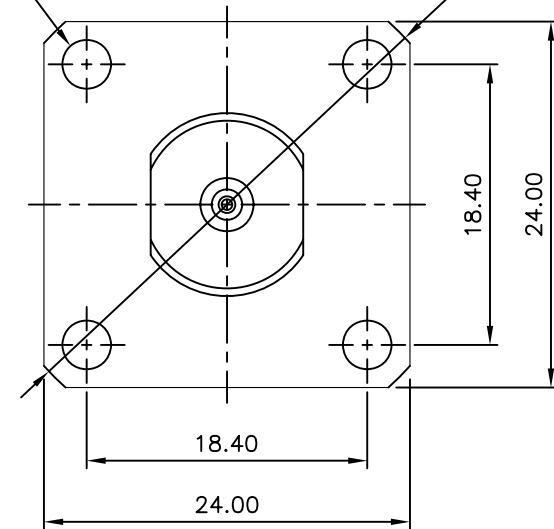
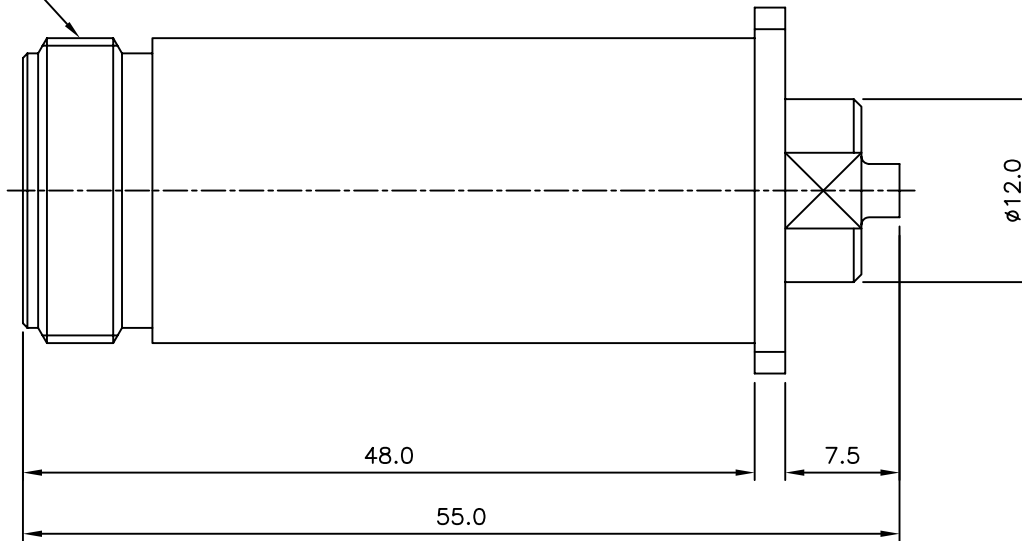


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.M.LEE	I.C.KIM	2015.05.18.

M20x1.0

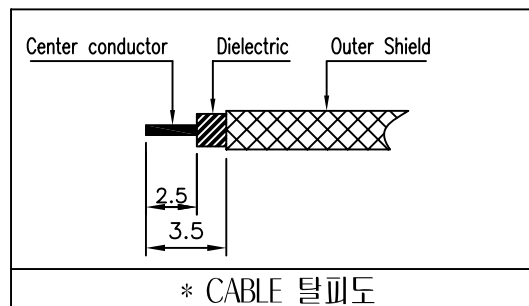
4- ϕ 3.2 thru

ϕ 32.0



*조립순서

- ⑥번을 ①번에 조립한다
- 1번 조립품에 ⑤번->④번 순서로 삽입한다.
- ②번과 ③번을 조립하고 땜을 한다.
4. 3에서 조립한 핀을 2번 조립품에 삽입 Ass'y 한다.
(CEQ00366-1/1 사용할 것)



6	BACK NUT	1	MBsBD C3604BD-F	SUCO Plate (5 μ m)	DBN0198-5/1
5	INSULATOR	1	TEFLON		DIN02514-N/2
4	INSULATOR	1	TEFLON		DIN02512-N/1
3	CONTACT	1	MBsBD C3604BD-F	Silver Plate (5 μ m)	DCT03335-5/2
2	CONTACT	1	BeCu C17300	Silver Plate (5 μ m)	DCT03330-5/1
1	BODY	1	MBsBD C3604BD-F	SUCO Plate (5 μ m)	DBD03941-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2015. 05. 18.	
	Angle	APPROVED BY	I.C.KIM
MATERIAL		CHECKED BY	H.J.LEE
		DRAWN BY	S.M.LEE
FINISH		SCALE	UNIT
		2/1	mm



TITLE		4.1/9.5DIN50 CABLE JS-4H 063F	
A4	DWG NO.	CN03359-7/3	
	REVISION	I R	SHEET 1 of 1